



Parameter	Rating	Units
Load Voltage	600	V _P
Load Current	±120	mA
On-Resistance (max)	35	Ω
Input Control Current	2	mA

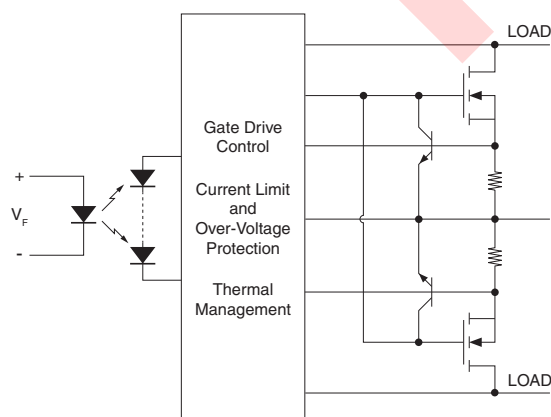
Features

- Integrated Active Current-Limit with Over-Voltage Protection
- Thermal Regulation
- 600V_P Blocking Voltage
- Guaranteed Turn-On: 2mA Input Control Current
- 3750V_{rms} Input/Output Isolation
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation

Applications

- In-Rush Current Control
- Heating, Ventilation, Air Conditioning Control (HVAC)
- Security Systems
- Power Supplies
- Home Appliances
- IC Equipment Protection
- Instrumentation
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Block Diagram



Description

The CPC1593 is a normally open (1-Form-A) Solid State Relay that incorporates load current limiting with over-voltage protection and thermal management. This self-resetting triple protection scheme protects not only the CPC1593's load, but also the CPC1593 itself, thus creating a highly effective switching mechanism that is designed to survive in the harshest operating environments.

Over-voltage protection is activated when the voltage across the switch is greater than 21V and the device is in current limit. The over-voltage protection deactivates the switch while allowing a restricted load current of less than 100μA to flow. When the voltage across the switch falls below the over-voltage threshold, the switches reactivate. If the fault persists, then these responses will repeat.

The CPC1593 is designed for use in AC environments where fault conditions can persist for long periods of time, and where, upon removal of the fault, return to normal operation is expected. The CPC1593 is designed to survive extended power cross conditions.

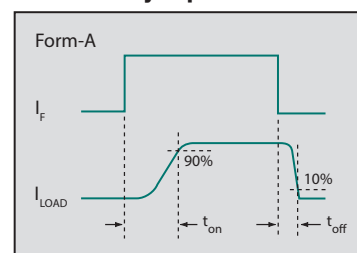
Approvals

- UL Recognized Component: File # E76270
- CSA Certified Component: Certificate # 1172007
- IEC EN 62368-1: TUV Certificate B 082667 0008

Ordering Information

Part #	Description
CPC1593G	6-Pin DIP (50/Tube)
CPC1593GS	6-Pin Surface Mount (50/Tube)
CPC1593GSTR	6-Pin Surface Mount, Tape & Reel (1000/Reel)

Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	600	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output (60 Seconds)	3750	V _{rms}
Operational Temperature (T _A)	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

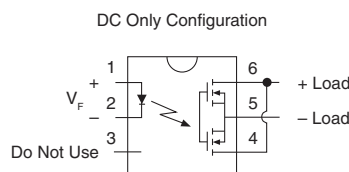
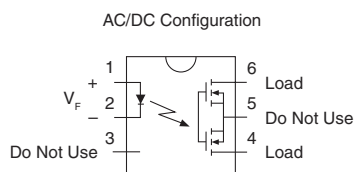
Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

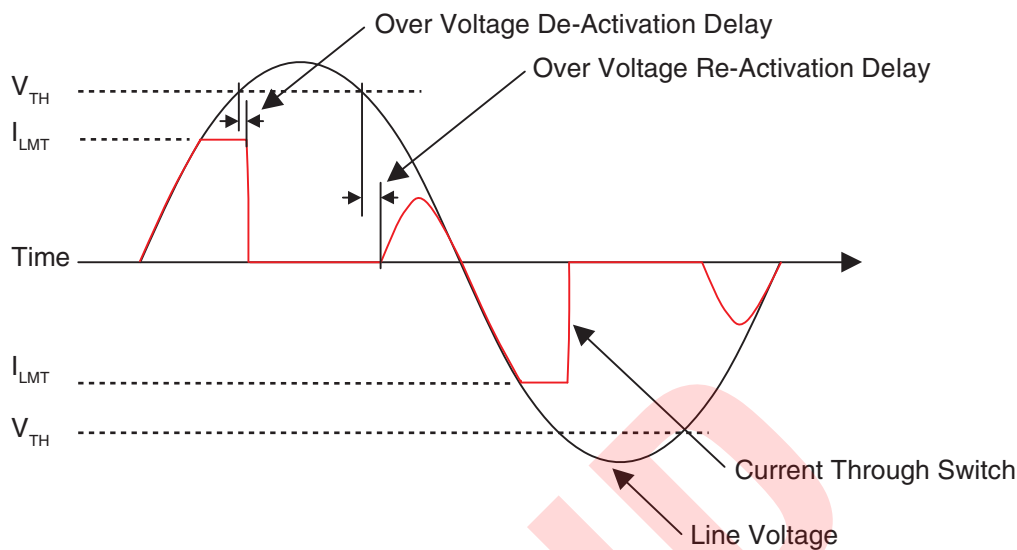
Recommended Operating Conditions

Parameter	Symbol	Configuration	Min	Typ	Max	Units
Load Current, Continuous	I _L	AC/DC	-	-	120	mA _{rms} / mA _{DC}
		DC-Only	-	-	250	mA _{DC}
Input Control Current	I _F	-	3	5	10	mA
Operating Temperature	T _A	-	-40	-	+85	°C

Electrical Characteristics @ 25°C

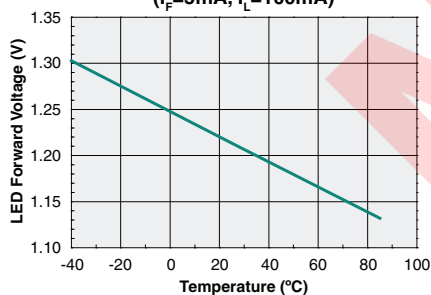
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Current Limit						
AC/DC Configuration	I _F =5mA, V _L =13V, t=5ms	I _{LMT}	±190	±225	±285	mA
DC Configuration	I _F =5mA, V _L =6.5V, t=5ms		360	430	570	
Over-Voltage Threshold	I _F =5mA	V _{TH}	17.5	21	-	V
On-Resistance						
AC/DC Configuration	I _F =5mA, I _L =120mA	R _{ON}	15	23	35	Ω
DC Configuration	I _F =5mA, I _L =220mA		3.75	7.38	11.75	
Off-State Leakage Current	V _L =600V	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, I _L =100mA	t _{on}	-	1.2	2	ms
Turn-Off		t _{off}	-	0.3		
Output Capacitance	I _F =0mA, V _L =20V, f=1MHz	C _O	-	18	-	pF
Input Characteristics						
Input Control Current to Activate	I _L =100mA	I _F	-	0.56	2	mA
Input Control Current to Deactivate	I _L <1μA	I _F	0.2	0.389	-	mA
LED Forward Voltage	I _F =5mA	V _F	0.9	1.24	1.5	V
Reverse Input Current	V _F = -5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	V _{IO} =0V, f=1MHz	C _{IO}	-	0.5	-	pF



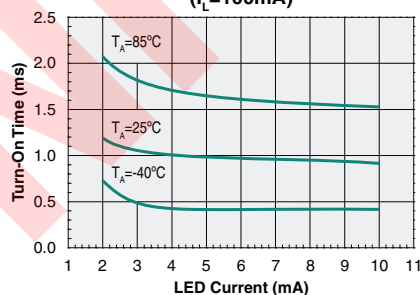
CPC1593 Waveforms: $R_L=0\Omega$ 

PERFORMANCE DATA *

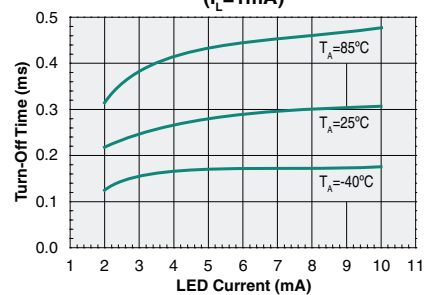
Typical LED Forward Voltage Drop
vs. Temperature
($I_F=5\text{mA}$, $I_L=100\text{mA}$)



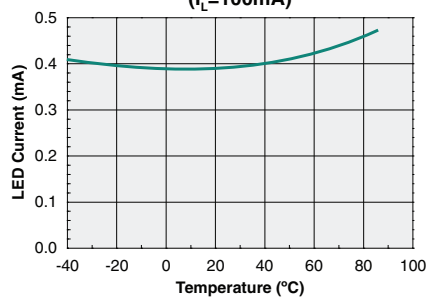
Typical Turn-On Time
vs. LED Forward Current
($I_L=100\text{mA}$)



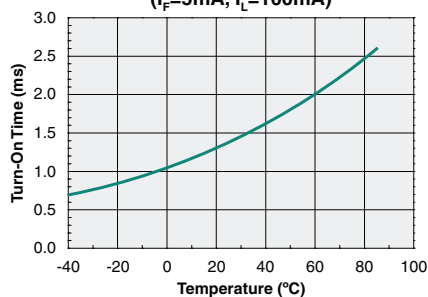
Typical Turn-Off Time
vs. LED Forward Current
($I_L=1\text{mA}$)



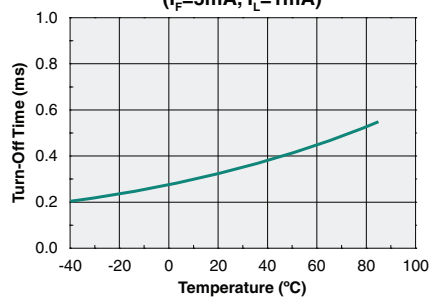
Typical I_F for Switch Operation
vs. Temperature
($I_L=100\text{mA}$)



Typical Turn-On Time
vs. Temperature
($I_F=5\text{mA}$, $I_L=100\text{mA}$)

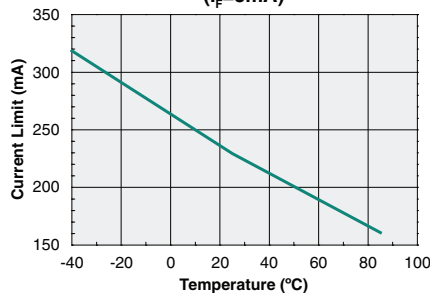
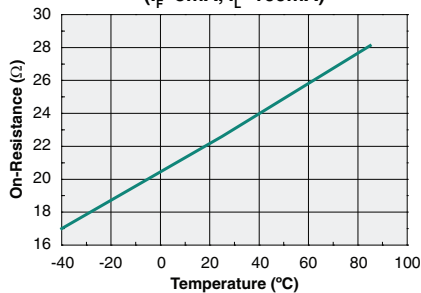
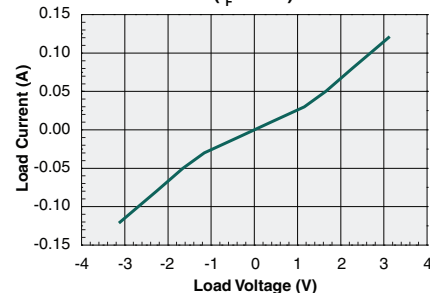
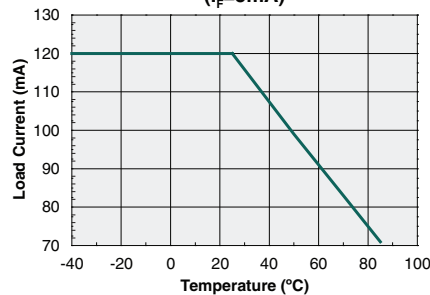
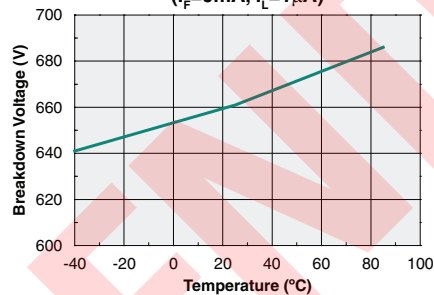
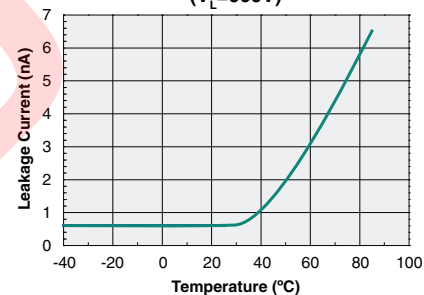
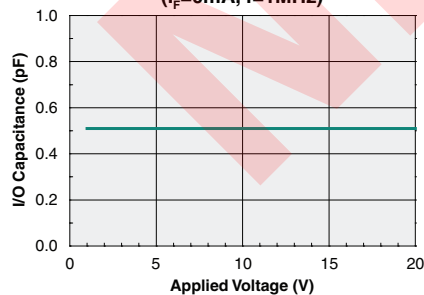
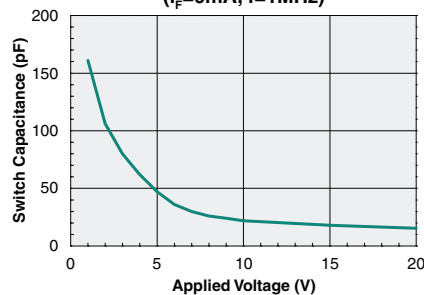


Typical Turn-Off Time
vs. Temperature
($I_F=5\text{mA}$, $I_L=1\text{mA}$)



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

**AC/DC Configuration Current Limit
vs. Temperature**
 $(I_F=5\text{mA})$

On-Resistance vs. Temperature
 $(I_F=5\text{mA}, I_L=100\text{mA})$

**Typical Load Current
vs. Load Voltage**
 $(I_F=5\text{mA})$

**Typical Load Current
vs. Temperature**
 $(I_F=5\text{mA})$

**Switch Blocking Voltage
vs. Temperature**
 $(I_F=0\text{mA}, I_L=1\mu\text{A})$

**Typical Leakage Current
vs. Temperature**
 $(V_L=600\text{V})$

**Input to Output Capacitance
vs. Applied Voltage**
 $(I_F=0\text{mA}, f=1\text{MHz})$

**Switch Capacitance
vs. Applied Voltage**
 $(I_F=0\text{mA}, f=1\text{MHz})$


*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
 For guaranteed parameters not indicated in the written specifications, please contact our application department.

Functional Description

The CPC1593 is an optically coupled Solid State Relay composed of an input LED, two output MOSFET switches, and a photovoltaic array with operational management circuitry that integrates switch control, an active current limit with excess power regulation and thermal supervision circuitry. Designed specifically for switching AC loads, the CPC1593 is ideal for controlling in-rush current by means of its integrated active current limit with excess power regulation feature. The CPC1593 may also be used for switching low voltage DC loads.

Biasing the input LED to activate the output switches while providing for proper performance over the operating temperature range and during load faults is dependent on adherence to the limits given for the Input Control Current parameter in the Recommended Operating Conditions table. Configuring the input drive circuit to provide a nominal LED current approximately equal to the typical value listed in the table will provide best overall performance.

The CPC1593 has two different operating configurations: (1) unidirectional "DC Only", and (2) bidirectional "AC/DC". When configured for unidirectional DC-only operation, the device is limited to switching load voltages having a known fixed polarity but when configured for AC/DC operation, the CPC1593 is capable of polarity independent voltage switching. The advantage of operating the device in the AC/DC configuration is the flexibility of switching AC load voltages while restricting in-rush current to the maximum current limit value shown in the Electrical Characteristics table without sacrificing fault protection.

Fault tolerance management at the CPC1593 load terminals is accomplished using a combination of current limiting, switch power regulation and thermal supervision. These features autonomously provide protection during fault conditions, then disengage once the fault clears allowing the device to automatically resume normal operation without external intervention.

Faults originate from a number of causes ranging from equipment malfunctions such as load integrity failure or load voltage supply failure to environmentally initiated events such as power line contact with outside cabling or ground bounce due to a nearby lightning strike. Generally when a potentially damaging fault condition occurs, it presents itself as an elevated voltage resulting in excess load current through the switch. Therefore, in this situation, the first line of defense is to limit the increasing load current.

Active current limiting circuitry within the CPC1593 provides protection for itself, the printed circuit board (PCB) traces and the load by restricting the surge current to a tolerable level. Limiting the fault load current regulates the maximum power across all of the load components external to the CPC1593. The consequence of limiting the power dissipation in the external load components is that the power load is shifted to the CPC1593. This is easily observed by monitoring the increasing voltage across the load terminals while in current limit.

Under these conditions the maximum power dissipation rating of the CPC1593 can be exceeded. To prevent this, the device must regulate the power dissipation of the output switches. This is accomplished by a significant reduction of the load current anytime the current limit function is active and the voltage across the load terminals exceeds the internally set Over-Voltage Threshold (V_{TH}). The load current is then reduced to less than $100\mu A$ and held at this level until the voltage across the load terminals decreases to less than V_{TH} at which point the outputs will resume normal operation. Should the fault condition persist, current limiting will begin again and the process will repeat. Continually cycling into current limit and over-voltage load current throttling ($I_L < 100\mu A$) with a long duration fault can result in excessive temperature rise within the device, driving it into thermal supervision.

Releasing the input control to deactivate the relay during current limiting or over-voltage load current throttling will reset these functions causing the relay to resume normal operation when the input control is re-asserted.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1593G / CPC1593GS	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Soldering Profile

Provided in the table below is the Classification Temperature (T_C) of this product and the maximum dwell time the body temperature of this device may be ($T_C - 5$)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature (T_C)	Dwell Time (t_p)	Max Reflow Cycles
CPC1593G	250°C	30 seconds	1
CPC1593GS	250°C	30 seconds	3

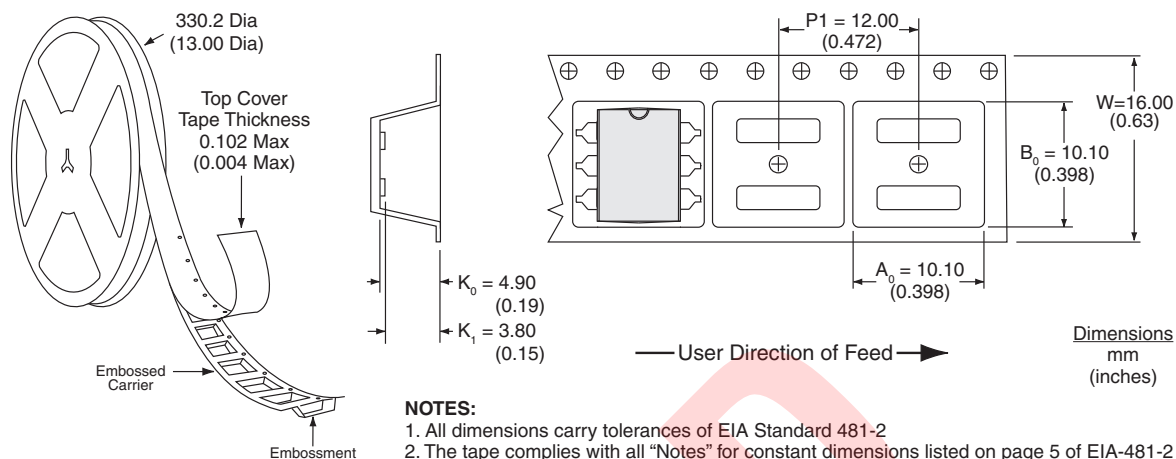
Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



MECHANICAL DIMENSIONS

CPC1593GSTR Tape & Reel



For additional information please visit our website at: www.ixysic.com

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